

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







VAOL-S6YP4

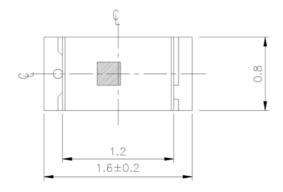
Features

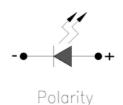
- Fit automatic placement equipment.
- Fit Compatible with infrared and vapor phase reflow solder process.
- Pb-free.
- RoHS compliant.

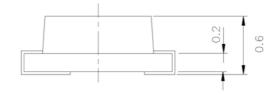
Descriptions

- For higher packing density .
- For minature applications.
- Water clear lens .
- Chip material: AlGaInP.
- Emitting color: Yellow.

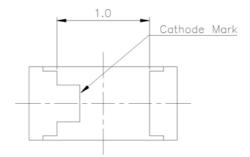
Package Outline Dimensions

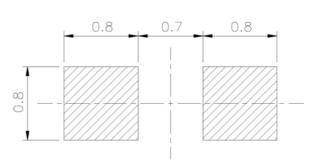






For reflow soldering (Propose)





Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm





Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	Vr	5	V	
Forward Current	${ m I}_{ m F}$	25	mA	
Operating Temperature	Topr	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Soldering Temperature	Tsol	260 (for 5 second)	$^{\circ}\! \mathbb{C}$	
Electrostatic Discharge (HBM)	ESD	2000	V	
Power Dissipation	Pd	60	mW	
Peak Forward Current (Duty 1/10 @1KHz)	I FP	160	mA	
Caldania Tananantana	T1	Reflow Soldering : 26	0 °C for 10 sec.	
Soldering Temperature	Tsol	Hand Soldering: 350	°C for 3 sec.	

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	16		50	mcd	
Viewing Angle	2 \theta 1/2		120		deg	
Peak Wavelength	λр		591		nm	I _F =10mA
Dominant Wavelength	λd	587		594	nm	IF—TOIIIA
Spectrum Radiation Bandwidth	Δλ		15		nm	
Forward Voltage	VF		1.9	2.3	V	
Reverse Current	IR			10	μ A	$V_R=5V$





Bin Range Of Luminous Intensity & Dom. Wavelength

Bin code	Min	Max	Unit	Condition	
M	16.0	32.0	mad		
N	25.0	50.0	med	IF=10mA	
4	587	590			
5	589	592	nm		
6	591	594			

Specific binning requirements- please contact our home office

Notes:

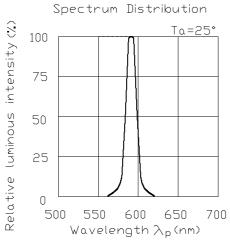
Tolerance of Dominant Wavelength ±1nm

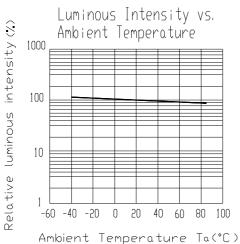


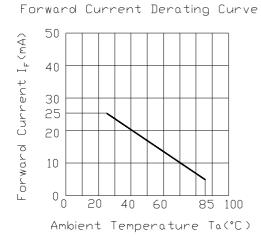


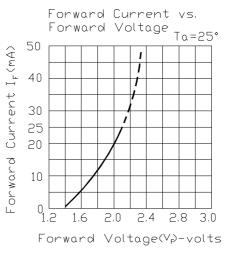


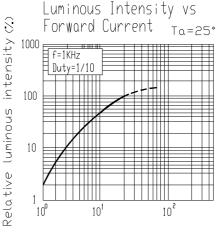
Typical Electro-Optical Characteristics Curves

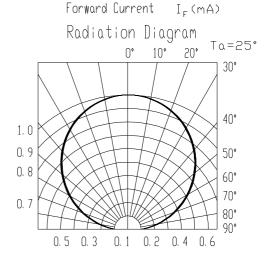








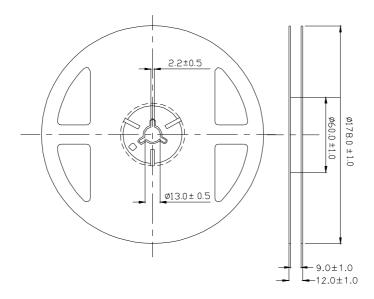








Reel Dimensions

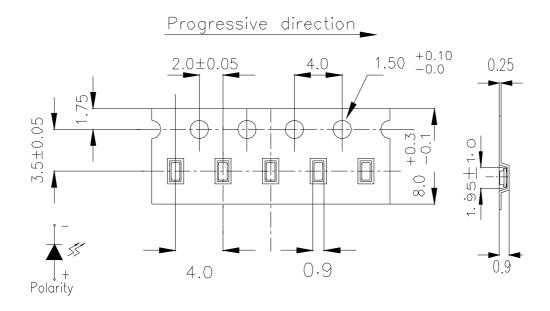


Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm



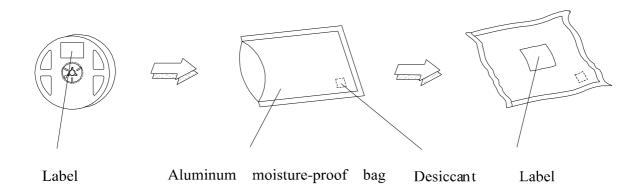


Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging

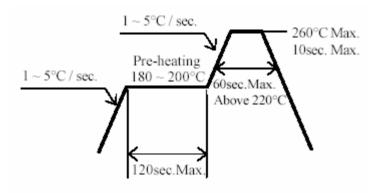






Soldering Condition

1.Pb-free solder temperature profile



- 2.Reflow soldering should not be done more than two times.
- 3 When soldering, do not put stress on the LEDs during heating.
- 4 After soldering, do not warp the circuit board.

Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.



